UNISONIC TECHNOLOGIES CO., LTD

16NM65 **Power MOSFET**

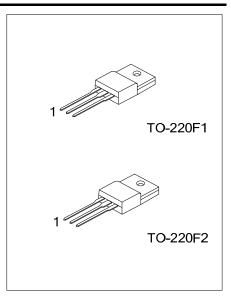
16A, 650V N-CHANNEL SUPER-JUNCTION MOSFET

DESCRIPTION

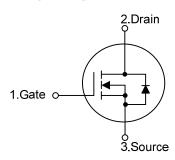
The UTC 16NM65 is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

FEATURES

- * $R_{DS(ON)} \le 0.35 \Omega @ V_{GS} = 10V, I_D = 8.0A$
- * High Switching Speed



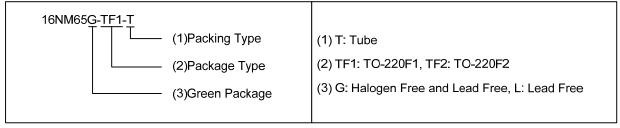
SYMBOL



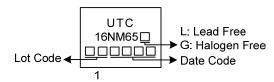
ORDERING INFORMATION

Ordering Number		Daakana	Pin Assignment			Daakina	
Lead Free	Halogen Free	Package	1	2	3	Packing	
16NM65L-TF1-T	16NM65G-TF1-T	TO-220F1	G	D	S	Tube	
16NM65L-TF2-T	16NM65G-TF2-T	TO-220F2	G	D	S	Tube	

Note: Pin Assignment: G: Gate S: Source D: Drain



MARKING



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■ ABSOLUTE MAXIMUM RATINGS (unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V_{DSS}	650	V	
Gate-Source Voltage		V_{GSS}	±30	V	
Continuous Drain Current	Continuous	I _D	16	Α	
	Pulsed	I _{DM} 48		Α	
Single Pulsed Avalanche Energy		E _{AS}	480	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	1.6	V/ns	
Power Dissipation		P _D	31	W	
Junction Temperature		TJ	+150	°C	
Storage Temperature		T _{STG}	-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 100mH, I_{AS} = 3.1A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25 $^{\circ}$ C
- 4. I_{SD} \leq 16A, di/dt \leq 200A/ μ s, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C

■ THERMAL DATA

PARAMETER	SYMBOL	RATING	UNIT	
Junction to Ambient	θја	62.5	°C/W	
Junction to Case	θјс	4.03	°C/W	

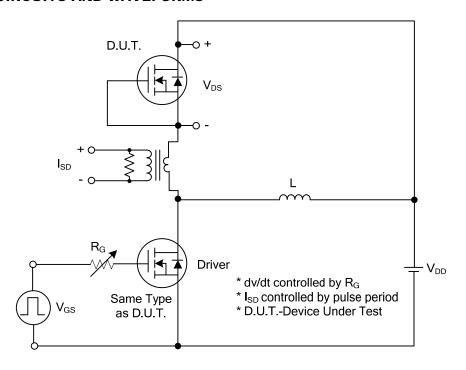
■ ELECTRICAL CHARACTERISTICS

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	I _D =250μA, V _{GS} =0V	650			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =650V, V _{GS} =0V			10	μΑ
Gate-Source Leakage Current	Forward	1	V_{GS} =+30V, V_{DS} =0V			+100	nA
	Reverse	Igss	V _{GS} =-30V, V _{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	$V_{DS}=V_{GS}$, $I_D=250\mu A$	2.5		4.5	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =8.0A			0.35	Ω
DYNAMIC PARAMETERS							
Input Capacitance		C _{ISS}			940		pF
Output Capacitance		Coss	V _{GS} =0V, V _{DS} =50V, f=1.0MHz		150		pF
Reverse Transfer Capacitance		C _{RSS}			6.6		pF
SWITCHING PARAMETERS							
Total Gate Charge		Q_G	V _{DS} =520V, V _{GS} =10V, I _D =16A (Note 1, 2)		50		nC
Gate to Source Charge		Q_GS			13		nC
Gate to Drain Charge		Q_GD	(Note 1, 2)		20		nC
Turn-ON Delay Time		t _{D(ON)}			12		ns
Rise Time		t _R	V _{DD} =100V, V _{GS} =10V, I _D =16A,		28		ns
Turn-OFF Delay Time		t _{D(OFF)}	R _G =25Ω (Note 1, 2)		110		ns
Fall-Time		t_{F}			40		ns
SOURCE- DRAIN DIODE RATI	NGS AND C	HARACTER	ISTICS				
Maximum Body-Diode Continuous Current		Is				16	Α
Maximum Body-Diode Pulsed Current		I _{SM}				48	Α
Drain-Source Diode Forward Voltage		V_{SD}	I _S =16A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time		t _{rr}	I _S =16A, V _{GS} =0V, dI _F /dt=100A/μs		420		ns
Reverse Recovery Charge		Q_{rr}	(Note 1)		7.1		μC

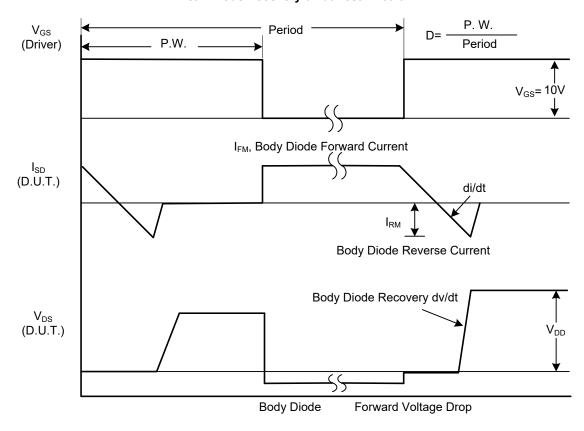
Notes: 1. Pulse Test: Pulse width ≤ 650µs, Duty cycle ≤ 2%.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

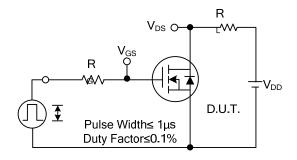


Peak Diode Recovery dv/dt Test Circuit

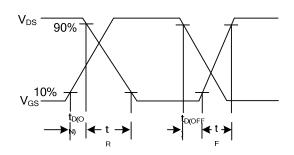


Peak Diode Recovery dv/dt Waveforms

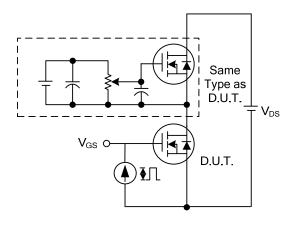
■ TEST CIRCUITS AND WAVEFORMS



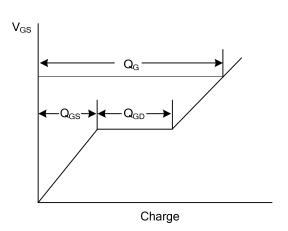
Switching Test Circuit



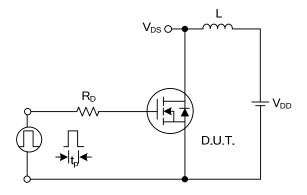
Switching Waveforms



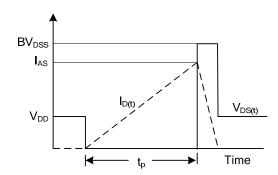
Gate Charge Test Circuit



Gate Charge Waveform

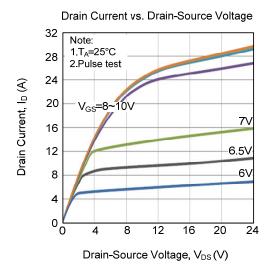


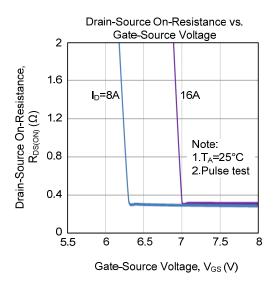
Unclamped Inductive Switching Test Circuit

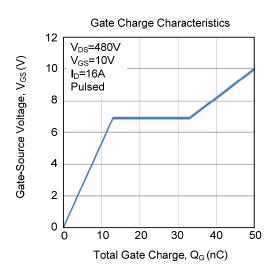


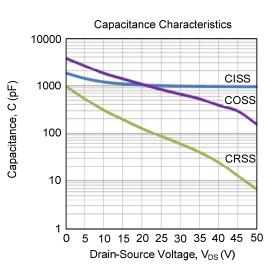
Unclamped Inductive Switching Waveforms

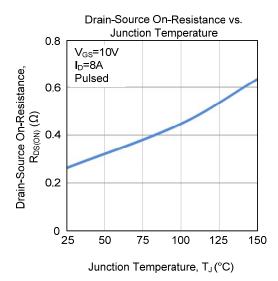
■ TYPICAL CHARACTERISTICS

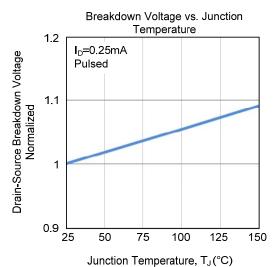




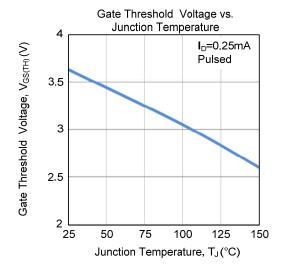


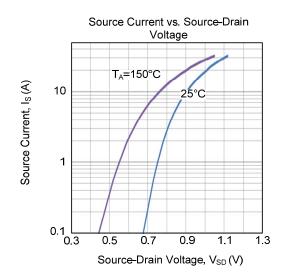


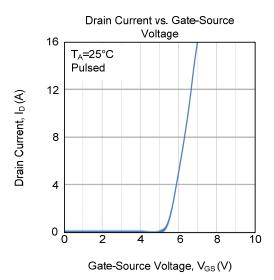


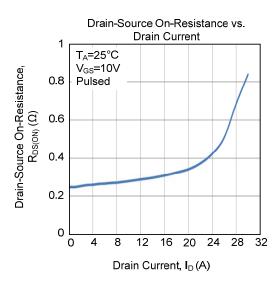


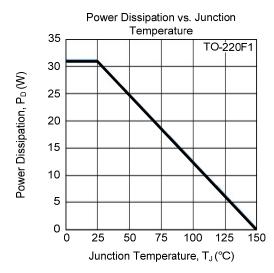
TYPICAL CHARACTERISTICS (Cont.)

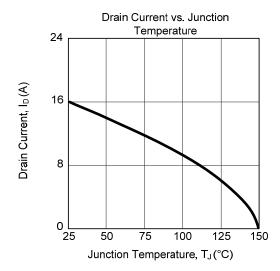




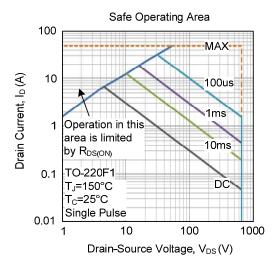








■ TYPICAL CHARACTERISTICS (Cont.)



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